This is in response to the Examiner's communication dated May 16, 2006.

I. Introduction

Claims 1–35 are pending in the above application.

Claims 1-6, 9-22, 25, 26 and 28-35 stand rejected under 35 U.S.C.

§102(b).

Claims 7, 8, 23, 24 and 27 stand rejected under 35 U.S.C. §103(a).

II. Amendments

The applicant has amended the title to more accurately reflect the invention.

The applicant has amended independent claims 1, 17 and 25 to more clearly claim the invention in view of the Examiner's objections. Applicant has also made minor voluntary amendments to dependent claims 2–7, 13–16, 18–24 and 27–35 to be consistent with the amended independent claims presented herewith.

III. Rejection Under 35 U.S.C. §102(b)

Claims 1–6, 9–22, 25, 26 and 28–35 stand rejected under 35 U.S.C. §102(b) as being anticipated by Gershenfeld et al. (6,025,725). Applicant respectfully traverses this rejection. Anticipation under 35 U.S.C. §102 requires that each and every element of the claim be disclosed in a prior art reference as arranged in the claim. See C. R. Bard, Inc. v. M3 Sys., Inc., 157 F. 3d 1340, 1349, 48 USPQ 2d (Fed. Cir. 1998); and Connell v. Sear, Roebuck & Co., 220 USPQ 193, 198 (Fed. Cir. 1983).

10

Appl. No. 10/517,769 Amdt. dated September 18, 2006 Reply to Office action of May 16, 2006

In Applicants' invention a resonant electromagnetic cavity is used, not a resonant LC circuit as disclosed and taught by Gershenfeld et al. For the monitoring of civil structures, it is important to have high strain resolution (ppm) and very good long term strain stability (5–10 ppm). For example, a large truck running over a medium sized bridge will typically produce strains of 10–50 ppm. This level of stability cannot be reasonably achieved with LRC resonators; C depends on many factors which can not be controlled to ppm levels over periods of years, L depends on many factors which can not be controlled to ppm levels over many years, and LC circuits can not achieve as high a Q as can be achieved in a cavity resonator. Applicants submit that Gershenfeld et al. recognized this and in their patent explicitly laid out arguments and experimental results showing the difficulty of using dimensional changes alone to measure strain:

"To appreciate the utility of the present invention in force-sensing applications, it is useful to model the response of a resonator constructed as shown in FIGS. 1A and 1B, but containing a conventional high-frequency dielectric (such as clear TEFLON in sheet form). The structure can be accurately represented as a simple LRC circuit including an inductor, resistor and plate capacitor with a dielectric material. By applying an elastic model to the deformation of the dielectric material under applied stress, the resonant frequency of the tag can be derived as a function of applied stress:

$$\omega_n = \omega_{n_0} \sqrt{\frac{E - \sigma}{E}}$$

where  $\omega_{n_0}$  is the resonant frequency of the tag absent any applied stress, E is the Young's Modulus of the dielectric material, and a is the applied stress. Rearranging this equation yields an expression relating the ratio of the change of resonant frequency versus initial resonant frequency and the induced strain,  $\in$ , in the dielectric material:

Appl. No. 10/517,769 Amdt. dated September 18, 2006 Reply to Office action of May 16, 2006

$$\frac{\Delta\omega}{\omega_{n_0}} = 1 - \sqrt{1 - \varepsilon}$$

"The measured data and the curve predicted by this model is included in FIG. 8 (discussed below) and very closely matched the measured data to within 0.1%. On this frequency scale, the change in resonant frequency appears as a flat line." Column 7, lines 22–53.

In the last line Gershenfeld et al. essentially concludes that it is not possible to measure strain with dielectrics such as Teflon<sup>TM</sup>. Gershenfeld et al. tries to convince the reader that strain can only be measured through the use of piezoelectric or similar dielectric materials. Applicant notes that Gershenfeld et al. uses the terms "LC-resonator," "LC-tank circuit," "LRC-resonator," "LC-package," and "flat LC-resonator package" in all Figures to their device. An LC-resonator is a resonant lumped circuit resonator device comprising of components that act as separate inductor (L) and capacitor (C) lumped element circuit components. Each element stores energy separately, with the energy oscillating between the components during resonance. The lumped L component typically has the highest loss (contributing to the R in the LRC-resonator) associated with its implementation due to current that flows through a conductor in an inductor (Gershenfeld et al. uses spiral L components in all drawings). This loss, results in a low Q-factor, and is the reason that strain cannot be measured using a dielectric LC-resonator as argued by Gershenfeld et al.

Applicants' invention discloses a different type of resonator, namely, an electromagnetic cavity resonator. Applicants' invention is distinct from the lumped element LC-resonator device of Gershenfeld et al. in its fundamental operation. In an electromagnetic cavity, energy is stored simultaneously in the coupled electric-magnetic field within a confining cavity (metallic encasement). If an air dielectric fills the cavity the fields experience no loss (except at the confinement walls of the cavity) and subsequently a very high Q-factor can be achieved (typically 10 times or more than with a lumped element LC resonator). Distinct from a lumped element LC-resonator, the

electromagnetic cavity geometry and dimensions can be designed to be resonant for different electromagnetic field configurations and frequencies. This enables the cavity to be tailored to a specific desired property and coupling approach.

For anticipation, "[t]he identical invention must be shown in as complete detail as is contained in the . . . claim." *Richardson v. Suzuki Motor Co.*, 868 F.2d 1226, 1236, 9 USPQ2d 1913, 1920 (Fed. Cir. 1989). Moreover, the elements must be arranged as required by the claim. *In re Bond*, 910 F.2d 831, 15 USPQ2d 1566 (Fed. Cir. 1990).

Geshenfeld et al. does not disclose, as now claimed in independent claims 1 and 17 and 25, a system, sensor and method for measuring strain experienced by a structure, where the sensor includes a body having an electromagnetic cavity, the electromagnetic cavity adapted to produce a response signal in response to an interrogation signal, the body being coupled to the structure to allow the strain to alter the resonance properties of the electromagnetic cavity thereby altering the response signal, and a coupler coupled to the body, the coupler adapted to transfer the interrogation signal into the electromagnetic cavity and transfer the response signal out of the electromagnetic cavity, and an interrogator being adapted to generate and transmit the interrogation signal to the sensor, the interrogator being further adapted to receive the response signal. Accordingly Gershenfeld et al. does not anticipate the invention as now claimed.

The dependent claims depend from these claims and therefore incorporate the limitations recited above with respect to the independent claims. Accordingly, applicant submits that the dependent claims are not anticipated by the Gershenfeld et al. reference.

## IV. Rejection Under 35 U.S.C. §103(a)

Appl. No. 10/517,769 Amdt. dated September 18, 2006 Reply to Office action of May 16, 2006

Claims 7, 8, 23, 24 and 27 stand rejected under 35 U.S.C. §103(a) as being unpatentable over Gershenfeld et al. in view of Spillman, Jr. (5,440,300). Applicant respectfully traverses this rejection.

As previously mentioned, Gershenfeld et al. essentially concludes (col. 7, lines 22–53) that it is not possible to measure strain with dielectrics such as Teflon<sup>TM</sup>. Gershenfeld et al. tries to convince the reader that strain can only be measured through the use of piezoelectric or similar dielectric materials. However, these materials suffer from serious hysterisis, thermal drift and aging problems. Applicants' submit that this provides convincing evidence that one skilled in the art would not see the use of resonant cavities as an obvious extension of Gershenfeld et al.'s teachings. Gershenfeld et al. does not teach applicants' invention; rather, applicants' submits, Gershenfeld et al. teaches away from the present invention. Accordingly, there can be no prima facie case of obviousness of modifying Gershenfeld et al. as suggested by the Examiner to provide the invention. In this regard see *In re Pye*, 148 USPQ 426, 429 (CCPA 1966) wherein the court held:

"While, as an abstract proposition, it might be possible to select certain statements from Fikentscher a mechanically combined and with Touey to arrive at appellants' claimed combination, we find absolutely no basis for making such a combination. Neither reference is directed to the problem solved by appellants' invention, namely developing a cleaning composition for the skin having improved lubricity characteristics. In our view only appellants' specification suggests any reason for combining the teachings of the prior art but use of such suggestion is, of course, improper under the mandate of 35 U.S.C. 103. In re Schaffer, 43 CCPA 758, 229 F.2d 476, 108 USPQ 326." (emphasis added)."

Applicant submits that there is no motivation to modify Gershenfeld et al. to provide the invention. Gershenfeld et al. nowhere recognizes the advantages of the

present invention. Without a suggestion of these advantages Gershenfeld et al. cannot

be obviously modified. See *In re Gordon*, 221 USPQ 1125, 1127 (Federal Circuit 1984):

"We are persuaded that the board erred in its conclusion of prima facie

obviousness...The mere fact that the prior art could be so modified would

not have made the modification obvious unless the prior art suggested the

desirability of the modification."

Moreover, for the Spillman, Jr. et al. invention, it is assumed that the

signal is digitized and processed within the embedded sensor before it is transmitted.

Applicants' sensor does not rely on digitizing the signal and the sensing information is

contained in the analog signal itself with no need for digital electronics, which would

require additional elements to process and digitize the sensor signal. This adds

considerable complexity and cost to the sensor. Additionally, it also limits the

interrogation of the embedded sensor to the specific data transfer protocol implemented

in the embedded sensor. This could be a considerable problem for civil structures where

sensors may be embedded for decades. There is a very real possibility that the specific

protocol used could become obsolete and the electronic components needed to transfer

data could become unavailable and unsupported.

Accordingly, in applicants submission, there is not even the most remote

suggestion in any way, shape or form of modifying the Gershenfeld et al. method or

apparatus either singly or combined with Spillman, Jr. et al., for the purposes of the

present invention as described and now claimed.

15

Appl. No. 10/517,769

Amdt. dated September 18, 2006

Reply to Office action of May 16, 2006

Applicant submits that this case is in condition for allowance. However, should the Examiner have any concerns with the claims as amended, applicant invites the Examiner to call the undersigned at (416) 957-1697 to discuss the case and avoid the expense and time of issuing a further communication.

Respectfully submitted,

**BERESKIN & PARR** 

By \_\_\_\_/ Stephen M. Beney

Reg. No. 4/1,563

Tel: (416) 957-1697